Rheological behaviour and thermal dilation effects of alumino-silicate adhesives intended for joining of high-temperature resistant sandwich structures

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ABSTRACT

The study is concerned with inorganic adhesive layers located between the CMC composite skin and the Si–O–C ceramic foam core of sandwiches intended for high-temperature use. Two types of alumino-silicate adhesives (mastics) were tested for use as the bonding layer. The rheological properties of adhesive and its dimensional changes during high-temperature curing play a key role in the terms of successful manufacture and subsequent use at high temperatures. In order to characterise these properties, specimens consisting of dried adhesive were subjected to compression tests conducted at increasing temperature from 300 to 1000 ℃. These experiments were carried out via the application of two loading modes—using both the static pre-load and cyclic loading methods. The above results were compared with thermal expansion records determined from fully-cured adhesives. In addition to the above investigation, the mechanical properties of the adhesive joint were measured employing both the DCB and shear tests.

1. Introduction

Sandwich structures consisting of refractory materials are potentially attractive for several industries, including aerospace and automotive [1]. Commonly used sandwich structures mainly provide considerable weight reduction, which is undoubtedly a great benefit. In the case of structures consisting exclusively of ceramic materials, such sandwiches offer an opportunity to resolve two additional important problems of advanced ceramics: First is the product price reduction by reducing the amount of very costly ceramic fibres which are used in the production of ceramic matrix composites (CMC). The second opportunity is more academic and involves the quest for improved fracture toughness and impact resistance of ceramics. Impact-resistant sandwich materials combining a polymer matrix laminate or metal with ceramics can be an inspiration for analogical solutions in the field of ceramic materials [2,3].

In view of the above facts, it is at first glance surprising, that sandwich structures consisting solely of ceramic materials are rarely discussed in scientific journals, in contrast to CMC which are still being further developed and which are being frequently discussed [4–17], similarly like ceramic foams [18–30] or porous ceramics [31–37]. The probable reason is, that the design and production of ceramic sandwich materials is quite a complicated problem, which requires the knowledge of several disciplines of materials sciences. In terms of structure, two basic varieties of ceramic sandwich core have been investigated: corrugated ceramic core [38] and ceramic foam core [39].

The interface between the ceramic core and the ceramic skin is a key problem for design and production of ceramic sandwiches. One possible solution is bonding with high-temperature inorganic adhesive. Joining of basic types of ceramics by using high-temperature adhesives is described e.g. in [40,41] for SiC and in [42,43] for Al2O3. High temperature inorganic adhesives for fixing of ceramics are currently often discussed in the context of solid oxide fuel cells, where they are used for joining the ceramic electrolyte with the frame of the fuel cell [44–56]. Unlike in case of structural sandwiches, the joints in fuel cells must be gas-tight. The operating temperatures of these joints reach up to 800 ℃. Similar

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demands are placed on high-temperature adhesives for fixing and sealing of perovskite membranes [57].

Bonding of CMC skin on a ceramic foam core is a separate and very challenging task. The adhesive connection between skin and foam core must meet several essential requirements:

1) The thermal expansion of all components of the sandwiches should be as similar as possible throughout the whole temperature range of the intended use.
2) The thermal expansion of the binder during its high-temperature curing should differ as little as possible from the expansion curve of fully cured binder.
3) The cured binder should have good adhesion to the skin as well as to the core in the whole temperature range of the intended use.
4) The non-cured binder should have a certain adhesion to the core and to the skin in the entire range of the high-temperature curing during the production of the sandwich.
5) When using a foam core, the binder should fill to some extent the pores, in order to increase the adhesion area. For this reason, it is advisable to use mastics with optimal filler grain size as binder.
6) None of the sandwich components should be affected by creep in the entire temperature range of the intended use. In particular, this demand applies to the high-temperature adhesive.

The aim of our study is to present a development and production process of a ceramic sandwich structure, with special focus on dilation and on rheological behaviour of the inorganic adhesive during its high-temperature curing process. These properties were studied in several types of compression experiments, using either cyclic load or static pre-load in the range from 300 to 1000 °C. The strength of the adhesive bond was tested in double cantilever beam (DCB) and in shear tests.

2. Material

The material investigated in this study is a high-temperature sandwich intended for use up to 1000 °C. The face sheet layers (skins) are made of a ceramic matrix composite (CMC) with a matrix based on pyrolyzed polymethylsiloxane resin (MS). The sandwich core is formed by a Si–O–C foam, which was prepared by pyrolysis of the polymethylphenylsiloxane resin (MPS). The skins and the core are bonded by an aluminosilicate adhesive (aluminosilicate mastic).

2.1. Skins

As an outer supporting layer, two variants of the fabric-reinforced CMC which differed in fibre type were used. The first type was Nextel 720 – a fibre having the alumina–mullite nanocrystalline structure. The elastic modulus of these fibres is 190 GPa and its maximum service temperature is 1300 °C. The second type was Nextel 610 – a fibre with pure alumina nanocrystalline structure which possesses improved creep resistance, elastic modulus of 300 GPa and a maximum service temperature of 1400 °C. Both types of composites have been produced by manual lamination of woven satin fabric which has been impregnated with the polymethylsiloxane (MS) resin. Plate-shaped samples were moulded and cured at a temperature/pressure controlled mode (up to 0.8 MPa and 250 °C). Subsequently, the composite plates were pyrolyzed at a slow heating rate up to 1100 °C (from 20 to 250 °C with 50 °C/h and from 250 to 1100 °C with 20 °C/h, followed by a 6 h dwell time at this temperature).

Structural changes in the MS precursor resin during the pyrolysis are described in [58,59]. The composite reinforced with Nextel 720 fibres (hereinafter N720) has a strength of 58 MPa, Young’s modulus of 66 GPa and apparent density of 2.24 g/cm³. The composite reinforced with Nextel 610 fibres (hereinafter N610) has a strength of 67 MPa, Young’s modulus of 92 GPa and density of 2.45 g/cm³.

2.2. Core

The foam core of the sandwich was produced by foaming the polymethylphenylsiloxane (MPS) resin with 12 wt.% of added starch. Foaming and curing of the preceramic foam took place simultaneously at 230 °C for 2 h. Subsequently, the foam was pyrolyzed at a slow heating rate up to 1100 °C using same temperature program as in the case of the skin plates (see 2.1). This foam has good mechanical properties, combined with good oxidation resistance at high temperatures, and its amorphous structure displays a high thermal stability. The low density of this foam is the key advantage for the use in sandwich structures. The production process and the properties of the foam are described in [26] and in [28]. The basic properties of the used foam are summarized in Table 1.

2.3. The adhesive layers of the studied sandwich structure

As a binder between the skins and the foam core, two types of high-temperature adhesives based on alumino-silicate mastic, which differ in their technological properties, were used. These two adhesives were selected in preliminary experiments among the six initially studied inorganic binders.

The initial intention of the authors was to produce a sandwich during foaming and curing of the core, without any adhesive layer, but significant differences in the shrinkage of the foam core and of the composite skins during pyrolysis did not allow implementing this intention. Second possibility of skin/core joining is the use of MS or MPS resin as adhesive after completed pyrolysis of the CMC skins and of the foam core. However, this method does not provide sufficient bonding strength after the pyrolysis of the adhesive resin layer.

Gluing of Si–O–C foam core and CMC composite skin by aluminosilicate adhesive was found to be successful and the adhesive provides a strong bond even where the bonded surfaces are separated by some distance – for example in a pore. The adhesive, however, forms an autonomous region with a thickness between ca. 0.1 and 1 mm, and therefore it must be considered as a separate layer which, by its mechanical properties, affects the entire sandwich.

The aluminosilicate adhesive with the trade name HT Silicate Adhesive (hereinafter SA) produced by Techniqil (Poland) is designed for the use at temperatures up to 1200 °C. The composition determined by EDS is: 55 wt.% of SiO2, 40 wt.% of Al2O3, 0.3 wt.% of Fe2O3 and 2.5 wt.% of Na2O + K2O. SA has a density of 2.22 g/cm³. The aluminosilicate adhesive Rudokit NT1350 (hereinafter RK – the manufacturer uses the term “mastic”) produced by P-D Rerfractories CZ a.s. in the Czech Republic is certified for the use up to 1350 °C. The chemical composition provided by the manufacturer.

![Table 1](http://dx.doi.org/10.1016/j.jeurceramsoc.2016.12.046)

Table 1

<table>
<thead>
<tr>
<th>Properties of the Si–O–C foam obtained from the MPS precursor.</th>
</tr>
</thead>
<tbody>
<tr>
<td>elemental composition</td>
</tr>
<tr>
<td>SiO14C24</td>
</tr>
</tbody>
</table>

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manufactur is: 57 wt.% of SiO₂, 38 wt.% of Al₂O₃, 0.6 wt.% of Fe₂O₃ and 3.5 wt.% of Na₂O+K₂O. Rk has a density of 2.12 g/cm³. An impor-
tant parameter is the maximum size of the filler particles, which in
the case of SA is equal to 0.1 mm, and in the case of Rk is equal to
0.5 mm. If the mastic is used as an adhesive, then this parameter
determines the minimum thickness of the adhesive layer. A deeper
study of structural transformations, which occur during the high-
temperature cure of the employed adhesives, is not a part of this
work.

2.4. The preparation of the sandwich samples for the mechanical
testing

The sandwich samples for the assessment of adhesion strength
were prepared by gluing upper and lower skins on the pyrolysed
foam core with the help of an alumino-silicate adhesive. Four vari-
ants were tested, using the mentioned two types of adhesive, i.e.
Rk or SA, and two types of composite skins, i.e. N610 or N720. All
of these sandwich variants were prepared in the same way: The
adhesive was applied between the pyrolysed foam and compos-
ite skin plate in a layer of 0.3–1 mm thickness depending on the
surface geometry and on the viscosity of untreated adhesive. The
sandwich sample was subsequently dried for one day at room tem-
perature. During drying, a strong hardening of the adhesives occurs,
combined with a good adhesion to all surfaces of the glued compo-
nents. Finally, the sandwich samples were annealed up to 1000 °C,
at a heating rate of 2.5 °C/min. (hereinafter the ‘high-temperature
curing’). The structure of the bonded joints is shown in Figs. 1 and 2.

3. Experimental

Measurements of dilation and of changes in rheological prop-
erties during the high-temperature curing were performed on
a standard testing machine Inspekt 100 (Hegewald & Peschke,
Germany), equipped with the testing furnace and with the
high-temperature bending/compression jig “PMA-06/V6 Biege-
Mess-Vorrichtung bis 1500 °C” (Maytec, Germany), using an
independent extensometer. The precision of the high-temperature
extensometer is ±0.03 μm. The above-mentioned jig was used
in a configuration for compression testing. The experimental
arrangement is shown in Fig. 3. The sample dimensions were
12 mm × 10 mm × 8 mm (the gauge length for the determination
of the dilations was 12 mm).

The DCB (double cantilever beam) and shear experiments were
carried out by the universal testing machine MTS Tytron 250. The
schemes of testing configurations are shown in Fig. 4. The applied
cross-head speed was 0.1 mm/min. Nominal dimensions of DCB
specimens prepared from sandwiches were 25 mm × 10 mm in
the joining plane (the skin size was 50 mm × 10 mm) and thickness
of approximately 15 mm depending on the final adhesive thickness.
Specimens for the shear test were the same like those for the DCB
test, but without one skin/adhesive layer.

Scanning electron microscopy (SEM) was employed for the
observation of the microstructure of the composites. A FEI Quanta
450 microscope was used, equipped with an ETD (detection of sec-
ondary electrons).

4. Results and discussion

4.1. Assessment of the thermally stabilized materials for the use
in the sandwich structures in terms of thermal expansion

During the manufacture, as well as during the operational use of
sandwich structures, considerable shear stresses arise due to differ-
tent temperature expansion coefficients of skin, core and adhesive
layers. The ideal situation would occur, if the thermal expansion
coefficients of all the components of the sandwich had the same
value. This situation cannot be achieved because of the limited choice of available high-quality ceramic fibres.

The experimental results of the thermal expansion of thermally stabilised materials (in the case of adhesives: high-temperature curing up to 1000 °C with 1 h dwell at this temperature; in the case of skins and core materials: pyrolysis up to 1100 °C), which were used as components in the investigated sandwich structures are shown in Fig. 5. Both adhesives display a similar behaviour of thermal expansion like the composite materials used for sandwich skins. The N610 composite skin and the Rk adhesive exhibit almost an identical course. The thermal expansion of the N720 composite is somewhat lower, which is a result of different crystal structures of the fibres in N610 and in N720 composites.

Among the investigated components, the Si–O–C foam exhibits by far the lowest thermal expansion, with a coefficient lower than 2·10⁻⁶. The difference between the thermal expansion coefficients of the foam core on one hand, and of the CMC skins and the cured adhesive on the other, could present a serious problem. However, a low elastic modulus of the foam still could allow for a proper function of the sandwich. If a simple sandwich model is considered, with mechanically non-deformable skins exhibiting thermal expansion and the foam exhibiting thermal expansion and elasticity, then the calculated compressive stress in the foam at 20 °C is 9 MPa, which is less than its compressive strength. This calculation assumes that a fully rigid connection between the skins and the core is formed at 1000 °C. If such a connection is formed at lower temperatures, the compressive stress will be lower. Phenomena like creep and vis-coelasticity of the adhesive, which are known to occur, also further reduce the compressive stress in the foam (after cooling down to 20 °C).

4.2. The rheological behaviour and the thermally induced dimension changes in the adhesive during the high-temperature curing

4.2.1. Experimental approach for characterization of the high-temperature curing process

The mechanical properties and the thermal expansion of individual components of sandwiches in a thermally stable state (after completed pyrolysis or annealing) are not the only criteria for their suitability. During the production of the sandwiches, the adhesive is undergoing significant structural transformations and its creep and thermal expansions or shrinkages play a significant role. The below-described experiments show that these properties can decide about the preparation method suitable for a particular sandwich design.

The sandwich structure developed in this work assumes the use of the CMC composite skins moulded and pyrolysed separately from the other components of the sandwich. Also the production of the foam core is proceeding separately until pyrolysis. Both of these components are sufficiently thermally stabilized and thereby, during the subsequent sandwich preparation, their properties will not change (for details see literature [10,26,59]).

During the high-temperature curing, which follows after the initial bonding of the sandwich, the adhesive undergoes crucial structural transformations accompanied by significant changes in mechanical properties and in dimensions. For the assessment of these changes, three types of experiments were conducted: 1) a rheological characterization of the adhesive during the cure pro-
value of expansion $\Delta L/L_0$ at a given temperature during high-temperature cure and under cyclic loading is the sum of four fundamentally different components: the first component is the reversible thermal expansion, the second is dilation resulting from thermally induced structure changes, the third component is the creep deformation caused by the cyclic loading and by preload applied to the sample, and the fourth is viscoelastic deformation in response to the cyclic loading and preload. Among these four effects, the reversible thermal expansion always has a positive value, the dilation originating in structure changes can be positive or negative (expansion or shrinkage), while creep and viscoelastic deformation always generate a negative expansion value. The fixation of the samples for cyclic compression (rheology) experiments (see Fig. 3) was carried out in a way which minimizes contact deformations between the sample and the high-temperature jigs (SiC compression segment and alumina stand). The mentioned undesired deformations occur always as consequence of uneven contact surfaces. In order to obtain even contact surfaces, a sparse layer of alumino-silicate adhesive was applied to the upper and to the lower contact surface of the measured sample. Subsequently, a preload of 10 N was applied to the sample, and it was heated up to 300 °C in the setup employed for the subsequent compression experiment (Fig. 3), at the rate of 5 °C/min. The described procedure led to the hardening of the contact layer between sample and jigs. The surface treatment of the samples was always immediately followed by the rheological experiments at cyclic loading.

All the rheology tests of the high-temperature adhesives were conducted on specimens sized 12 mm x 10 mm x 8 mm which were dried and hardened at room temperature. In the course of the experiments, the temperature was raised from 300 °C to 1000 °C, at a heating rate of 2 °C/min. The experiments were performed on the standard testing machine equipped with a furnace and with a high-temperature compression jig, which had an integrated high-temperature extensometer (Fig. 3).

The typical rheological behaviour of the alumino-silicate adhesives is illustrated in Figs. 6 and 7: The Fig. 7a displays the detail of one cyclic loading step recorded at the temperatures of 650–658 °C, where the dried adhesive starts to soften. The trapezoidal loading pulse applied by the jigs is plotted as the thin line. The sample deformation caused by this pulse, which is plotted as the thick line, indicates a predominantly viscoelastic behaviour, manifested by a delayed deformation response. Irreversible plastic deformation also takes place, but its exact extent is not evident from the detail shown in Fig. 7a. In the range between 700 and 800 °C, the amplitude of the strain response to loading cycles gradually

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Fig. 6. Experiment studying the rheological and dimensional changes during the high-temperature cure of the alumino-silicate adhesive (material: SA adhesive), by applying cyclic load.

Fig. 7. Detail of one load cycle from Fig. 6: a) cycle at 650 °C; b) cycle at 950 °C.

diminishes until it practically disappears, as consequence of the progressing high-temperature cure of in the studied adhesive. The adhesive becomes softer again, if 900 °C are exceeded. Above this temperature, the deformation response has a completely different nature (Fig. 7b), approaching ideal elastic behaviour (only a small viscosity-generated deformation delay is observed).

4.2.2. Viscoelasticity, dimensional changes, and creep effects at high-temperature curing of investigated adhesives

Dilation induced by structural changes which occur during the high temperatures curing of the alumino-silicate adhesives poses a significant problem, because this dilation vastly exceeds the thermal expansion of the stabilized material, and also the creep deformation achievable at temperatures below 680 °C (SA adhesive) or 900 °C (Rk adhesive), as illustrated in Figs. 8 and 9, respectively. Mutual distinction of particular dilation effects and of rheological mechanisms can be done in three experiments, the results of which are shown for the SA adhesive in Fig. 8 and for the Rk adhesive in Fig. 9. The above-described experiment of cyclic loading is plotted with the thin blue line. The bold brown line indicates a similar experiment, i.e. $\Delta L/L_0$ measurement for the adhesive during its cure, but at a constant preload of 5 N instead of cyclic loading. This experiment (brown line) was carried out on adhesives, which were dried and hardened at room temperature, and also the heating rate was the same like in the experiment with the cyclic load. The constant-load-experiment describes the course of dilations associated with the high-temperature curing process, i.e. with irreversible structural changes; the 'chemical dilations' are superimposed onto simple thermal dilation of the material. The third experiment, plotted with the yellow line, characterizes the course of the reversible thermal expansion, and was performed under exactly the same thermal and mechanical conditions like the static-load experiment, but on adhesive samples whose structure was fully cured and stabilized by one-hour-annealing at 1000 °C. The course of the dimensional changes of the SA adhesive during its high-temperature cure is shown in Fig. 8. The expansion peak induced by structure changes begins to rise at 430 °C and reaches the maximum value of 1.5% at 623 °C. The magnitude of this expansion vastly exceeds the thermal dilation of the stabilized (cured) SA adhesive, which, in same temperature range, reaches 0.38%. A similar expansion peak was observed in the case of the cure of inorganic adhesives e.g. in [44,45 and 49]. Chang et al. [49] identify the beginning of the peak as a 'temperature of softening' and its maximum as the glass transition temperature. Above the temperature of 800 °C, the course of the dilation is nearly identical for the curing and for the thermally stabilized (fully cured) SA adhesive.

The rheological behaviour of the curing SA adhesive has been partly discussed above. Marked is the appearance and prominence of softening, of viscoelastic behaviour, and of creep in the range between 600 and 800 °C. The temperature-dependent viscoelastic deformation can be evaluated as the amplitude of displacement...
achieved during the respective cyclic load. Creep is evident in this temperature range from the difference between the dilation curve recorded under cyclic load and the curve measured with preload. In the case of the first curve, the creep occurs during the particular loading pulses. The accumulated plastic deformation (as result of cyclic loading) reaches approximately 1% at the end of the softening range at ca. 810 °C. The observed plasticity may favourably compensate the internal stresses caused by different dilations of sandwich components during the high-temperature gluing. Between 800 and 900 °C, the SA adhesive does not exhibit any creep or viscoelasticity. The softening which occurs at temperatures above 900 °C is a constant phenomenon, which persists also after full cure (thermal stabilization), and therefore it can have a negative impact in the case of long-term use of the sandwich at high temperatures: A small shear displacement of the skin layers could cause an unacceptably large change in the shape of the sandwich.

Also the Rk adhesive (Fig. 9) exhibits dilations induced by structure changes during its high-temperature cure. The course of these dilations, however, is different from the one observed for the SA adhesive. A distinct onset occurs above 540 °C. The maximum value of 0.7% (after subtraction of thermal expansion) is reached at 775 °C, i.e. 150 °C higher than in the case of SA. Further temperature increase leads to the shrinkage of the curing Rk sample, and at the temperature of 1000 °C, the sample height is back at the value achieved previously at 300 °C. A favourable property of the Rk adhesive is the relatively low value of the maximum dilation induced by structure changes, which is roughly two times smaller in comparison with SA.

From the rheological viewpoint, the Rk adhesive does not exhibit hardening at higher temperatures, in contrast to SA, which becomes stiff between 800 and 900 °C. The amplitude of the deformation response to cyclic loading begins to be visible above 550 °C, and it uniformly increases up to the end of the experiment at 1000 °C. In comparison with SA, the strain amplitude is lower in the entire temperature range investigated. The deformation mechanism is rather viscoelastic without creep, which becomes evident in view of the almost identical courses of dilation under cyclic load and of dilation with preload. The low ability of the material to deform plastically at the temperatures of maximum structural changes is an adverse property, which could negatively affect the strength of the adhesive joint in a sandwich glued with Rk.

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4.3. Assessment of the quality of the glued joints

The quality of the sandwiches joined by the studied adhesives was experimentally evaluated by means of a modified DCB (Double-Cantilever-Beam) test, which is commonly used for the characterisation of delamination in composites. Additionally, specimens of the sandwiches were also subjected to shear tests. The Fig. 4 shows the experimental setup for both the mentioned tests. The first aim was to identify the weakest point of the tested joint. The recorded load-opening traces were evaluated, and the maximum applied loads, as well as the energies consumed for the formation of new surfaces were determined. The type of fracture was determined by ‘post mortem’ visual evaluation of the broken specimens. Generally, five fracture types (categories) which are identified in view of the fracture location, can be distinguished: i) delamination or fracture within the fibre-reinforced composite skin, i.e. delamination of the composite interlayers, ii) interface fracture going through the composite-adhesive interface, iii) fracture going through the adhesive, iv) interface fracture going through the adhesive-core interface and v) fracture occurring in the ceramic foam core. The last type could be divided into foam fracture close to the joint, and into fracture in the central region of the foam layer. The latter division makes possible to recognize situations, where damage to the foam layer was caused by expansion mismatch (adhesive vs. core) during the heat treatment of the joint. Such damage predetermines foam cracking near the joint. Examples of the most common fracture types observed in this study are presented in Fig. 10, and they make possible the selection of the combinations of materials which yield the most promising sandwiches. Generally, it can be seen, that the fracture of the core is the most frequent destruction path if the Rk adhesive in combination with N610 skin is employed. In case of the SA adhesive, the location of the fracture is rather randomly distributed and the fracture process appears to be controlled by location of initial crack-size-defects. Fig. 11 summarises the energy consumption values measured during DCB experiments. The results are sorted to groups which are defined by the location of the fracture. The energy consumed for the formation of new surfaces, i.e. the work of fracture (WoF) normalised by fracture surface was found to be the highest for the fractures which occurred in the joints, and reached its maximum (approximately 0.03 mJ/mm²) for the fracture going through the adhesive layer. The composite delamination path exhibited twofold lower, but second highest WoF values. Finally, the lowest values (see Fig. 11) were observed for the most frequently occurring fracture type, namely for the one going through the foam. In this latter case, the consumed energy was on the level of 0.004 mJ/mm², which is one order lower than the values obtained if the fracture goes through the adhesive layer.

In the DCB test, the fracture of the sandwich starts from the weakest point (defect), which is usually found in the core layer. In order to more thoroughly evaluate the adhesive efficiency in the sandwich, shear tests were conducted and the obtained results are summarised in Fig. 12, where the normalised de-cohesion force is plotted against the location of the fracture. In this comparison, we can see only negligible differences in the measured force levels. The trend, however, corresponds well with the results plotted in Fig. 11. In some cases, the joint was stronger than the composite itself (note that the de-cohesion forces are only indicative because they are related to joint surface and not to the real fracture surface). Table 2 explains the lower bond strength of the sandwiches based on the N610 composite skin and bonded by the Rk adhesive: For most of these specimens, the fracture damage was localized exclusively in the foam core. This is probably a consequence of curing dilations which damaged the foam core during the high-temperature gluing of the sandwich. This adverse effect was paradoxically supported by the higher interlaminar strength of the N610 composite skin, which led to the rise of higher shear tensions during the gluing process, and as consequence, to a higher damage to the foam core prior to the mechanical tests. On the contrary, the combination of
Table 2
Normalised work of fracture (WoF) and subjective evaluation of failure aspects.

<table>
<thead>
<tr>
<th>Sandwich composition</th>
<th>Frequency of failure</th>
<th>Average WoF/A (mJ/mm²)</th>
<th>Adhesion strength</th>
<th>Core damage</th>
<th>Skin interlayer quality</th>
</tr>
</thead>
<tbody>
<tr>
<td>Skin</td>
<td>N720</td>
<td>25%</td>
<td>0.0129 ± 0.0091</td>
<td>very good</td>
<td>very good low</td>
</tr>
<tr>
<td>Adhesive</td>
<td>SA</td>
<td>30%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Core</td>
<td>SiOC</td>
<td>45%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Skin</td>
<td>N720</td>
<td>55%</td>
<td>0.0117 ± 0.0073</td>
<td>very good</td>
<td>very good low</td>
</tr>
<tr>
<td>Adhesive</td>
<td>Rk</td>
<td>10%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Core</td>
<td>SiOC</td>
<td>35%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Skin</td>
<td>N610</td>
<td>0%</td>
<td>0.0020 ± 0.0015</td>
<td>excellent</td>
<td>very good medium</td>
</tr>
<tr>
<td>Adhesive</td>
<td>SA</td>
<td>40%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Core</td>
<td>SiOC</td>
<td>60%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Skin</td>
<td>N610</td>
<td>0%</td>
<td>0.0035 ± 0.0025</td>
<td>excellent</td>
<td>very good high</td>
</tr>
<tr>
<td>Adhesive</td>
<td>Rk</td>
<td>15%</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Core</td>
<td>SiOC</td>
<td>85%</td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

which resulted from structure changes occurring during the high-temperature cure of both types of the investigated adhesives.

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